

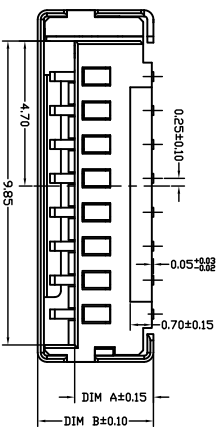
RECOMMENDED PCB LAYOUT  
TOLERANCES ±0.05

NOTE:  
MATERIAL:

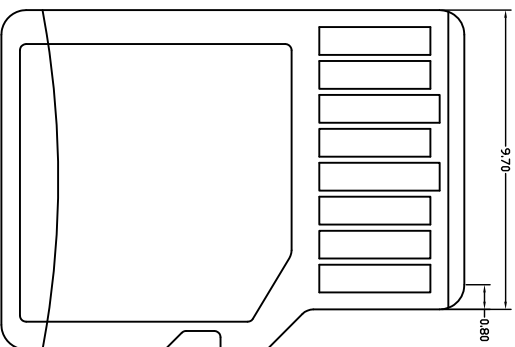
1. HOUSING: LCP-30%/F UL 94-V0 BLACK
2. SIGNAL TERMINAL/DETECT TERMINAL: PHOSPHOR BRONZE
3. SHELL: STAINLESS STEEL

FINISH:

1. SIGNAL TERMINAL: 1.25-6.25 MICRON NICKEL MIN UNDER-PLATED  
0.5-1.0 MICRON GOLD MIN ON CONTACT AREA  
GOLD FLASH PLATED ON CONTACT AREA.
2. SHELL: GOLD FLASH PLATED OVER NICKEL ON SOLDER AREA.  
GOLD FLASH PLATED ON CONTACT AREA
3. DETECT: 1.25-6.25 MICRON NICKEL MIN UNDER-PLATED,  
TIN PLATED ON SOLDER AREA.



1.45	2.65	TH35-TF08-265
1.65	2.85	TH35-TF08-285
1.80	3.00	TH35-TF08-300
2.55	3.75	TH35-TF08-375
DIM A	DIM B	PATR No.



鉅創科技有限公司  
TRONTEK TECHNOLOGY CO., LTD.

DRAWN BY: ANDY DATE: 2014-3-13  
PART NAME: TF SIMPLE TYPE

CHECKED BY: FRANK DATE: 2014-3-13  
PART NO.: TH35-TF08-XX

APPROVED BY: DATE: 2014-3-13  
MOLD NO.:  
DRAW NO.:

SCALE: 1:1 SIZE: A4  
DAVID SHEET NO.: 10P1

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